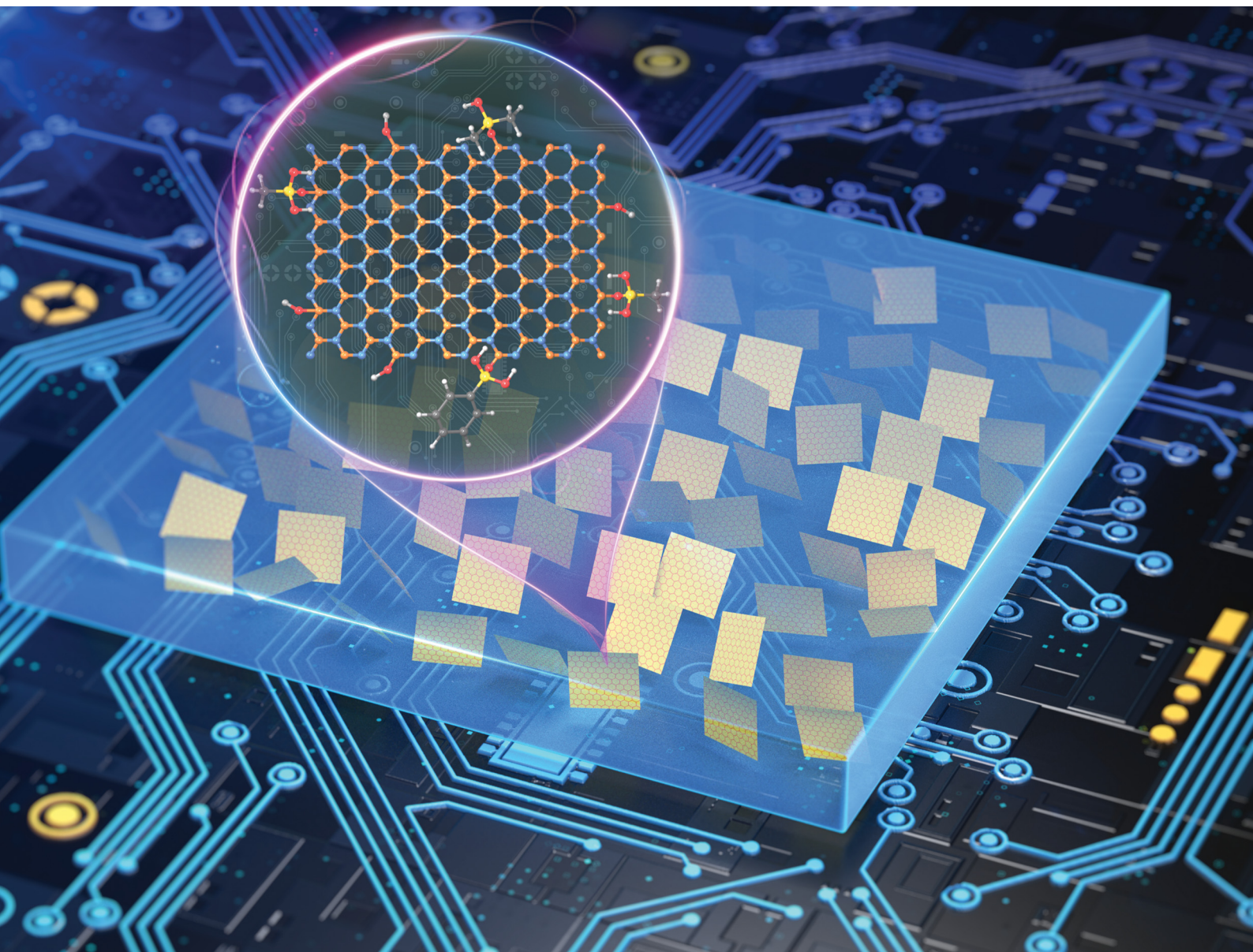


# Materials Advances

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**PAPER**

Zhenxing Chen, Ziwei Li *et al.*  
Improved out-of-plane thermal conductivity of boron nitride  
nanosheet-filled polyamide 6/polyethylene terephthalate  
composites by a rapid solidification method